

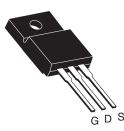
RoHS

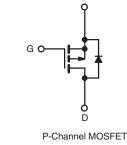
COMPLIANT

## Power MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	- 100				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = - 10 V	0.60			
Q <sub>g</sub> (Max.) (nC)	18				
Q <sub>gs</sub> (nC)	3.0				
Q <sub>gd</sub> (nC)	9.0				
Configuration	Single				

### **TO-220 FULLPAK**





### **FEATURES**

- Isolated Package
- High Voltage Isolation = 2.5 kV<sub>RMS</sub> (t = 60 s; f = 60 Hz
- Sink to Lead Creepage Distance = 4.8 mm
- P-Channel
- 175 °C Operating Temperature
- Dynamic dV/dt Rating
- · Low Thermal Resistance
- Lead (Pb)-free Available

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The moulding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	IRFI9520GPbF
	SiHFI9520G-E3
SnPb	IRFI9520G
	SiHFI9520G

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PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	- 100	v	
Gate-Source Voltage			V <sub>GS</sub>	± 20		
Continuous Drain Current	Vec at - 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	1-	- 5.2		
	VGS at - TO V	$T_{C} = 100 ^{\circ}C$	ID	- 3.6	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	- 21		
Linear Derating Factor				0.24	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	300	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	- 5.2	A	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	3.7	mJ	
Maximum Power Dissipation	T <sub>C</sub> =	25 °C	PD	37	W	
Peak Diode Recovery dV/dtc			dV/dt	- 5.5	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C		
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	1	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
			_	1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b.  $V_{DD} = -25 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 16 mH,  $R_G = 25 \Omega$ ,  $I_{AS} = -5.2 \text{ A}$  (see fig. 12). c.  $I_{SD} \leq -6.8 \text{ A}$ , dl/dt  $\leq 110 \text{ A/}\mu\text{s}$ ,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 175 \text{ °C}$ . d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply





PARAMETER	SYMBOL	TYP. MAX.			UNIT					
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 65								
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>				°C/W					
		1								
SPECIFICATIONS $T_J = 25 \ ^{\circ}C$ , u	unless otherv	vise noted								
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT		
Static										
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	50 µA	- 100	-	-	V		
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I	<sub>D</sub> = - 1 mA	-	- 0.10	-	V/°C		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	50 μA	- 2.0	-	- 4.0	V		
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 20 V			-	-	± 100	nA		
Zara Cata Valtaga Drain Current	V <sub>DS</sub> = - 100 V, V <sub>GS</sub> =	s = 0 V	-	-	- 100					
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 80 V	′, V <sub>GS</sub> = 0 V	, T <sub>J</sub> = 150 °C	-	-	- 500	μΑ		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> =	- 3.1 A <sup>b</sup>	-	-	0.60	Ω		
Forward Transconductance	<b>g</b> <sub>fs</sub>	V <sub>DS</sub> = -	- 50 V, I <sub>D</sub> =	- 3.1 A <sup>b</sup>	1.9	-	-	S		
Dynamic										
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = -25 V,$ f = 1.0 MHz, see fig. 5		-	390	-	pF			
Output Capacitance	C <sub>oss</sub>			-	170	-				
Reverse Transfer Capacitance	C <sub>rss</sub>			-	45	-				
Drain to Sink Capacitance	С		f = 1.0 MHz		-	12	-	1		
Total Gate Charge	Qg			-	-	18				
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V		6.8 A, V <sub>DS</sub> = - 80 V, ee fig. 6 and 13 <sup>b</sup>	-	-	3.0	nC		
Gate-Drain Charge	Q <sub>gd</sub>		see lig. 6 and 15		-	-	9.0	1		
Turn-On Delay Time	t <sub>d(on)</sub>				-	9.6	-			
Rise Time	t <sub>r</sub>	$V_{DD} = -50 \text{ V}, \text{ I}_D = -6.8 \text{ A}, \\ R_G = 18 \Omega, R_D = 7.1 \Omega, \\ \text{see fig. } 10^{\text{b}}$		-	29	-	ns			
Turn-Off Delay Time	t <sub>d(off)</sub>			-	21	-				
Fall Time	t <sub>f</sub>				-	25	-	1		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-				
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	nH			
Drain-Source Body Diode Characteristic	s									
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 5.2	A			
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	- 21				
Body Diode Voltage	$V_{SD}$	$T_J$ = 25 °C, $I_S$ = - 5.2 A, $V_{GS}$ = 0 V <sup>b</sup>		-	-	- 6.3	V			
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- $T_J = 25 \text{ °C}, I_F = -6.8 \text{ A}, dl/dt = 100 \text{ A}/\mu\text{s}^{b}$		-	100	200	ns			
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.33	0.66	μC			
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and I					D)			

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.





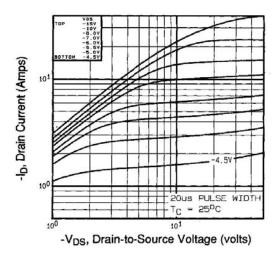


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

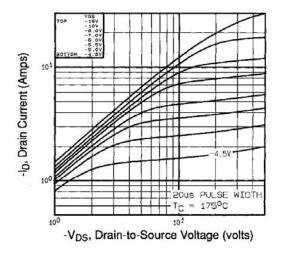


Fig. 2 - Typical Output Characteristics,  $T_C$  = 175  $^\circ C$ 

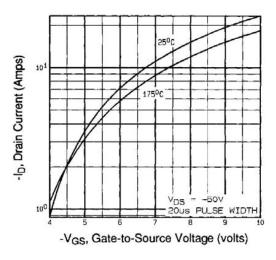


Fig. 3 - Typical Transfer Characteristics

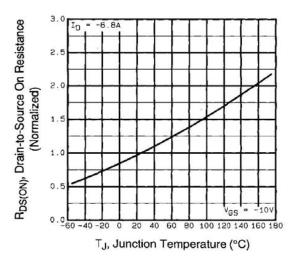


Fig. 4 - Normalized On-Resistance vs. Temperature

# IRFI9520G, SiHFI9520G

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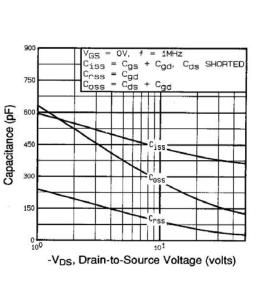


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

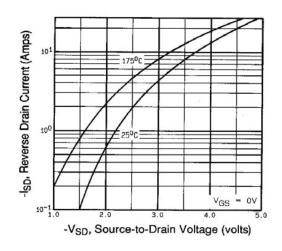


Fig. 7 - Typical Source-Drain Diode Forward Voltage

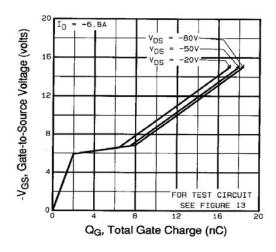


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

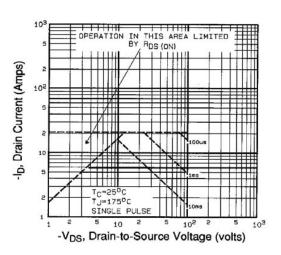


Fig. 8 - Maximum Safe Operating Area



## IRFI9520G, SiHFI9520G

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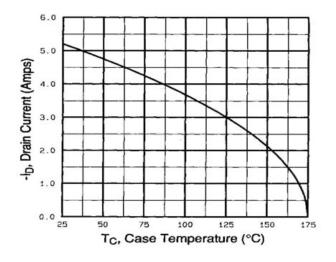


Fig. 9 - Maximum Drain Current vs. Case Temperature

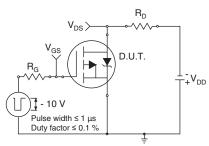


Fig. 10a - Switching Time Test Circuit

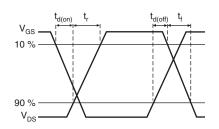
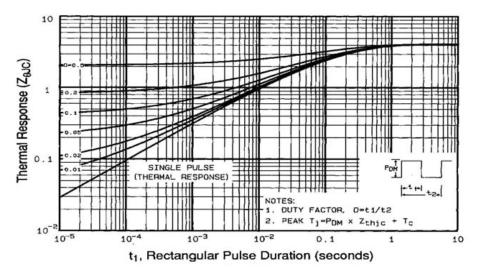


Fig. 10b - Switching Time Waveforms





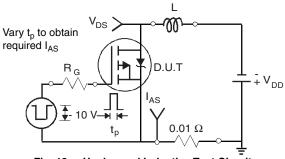


Fig. 12a - Unclamped Inductive Test Circuit

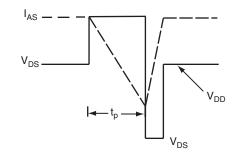
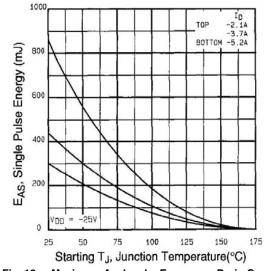


Fig. 12b - Unclamped Inductive Waveforms

# IRFI9520G, SiHFI9520G

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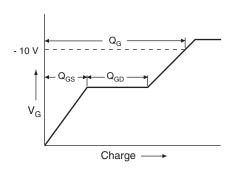
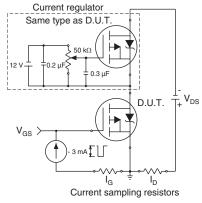


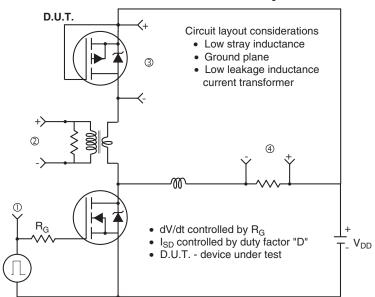
Fig. 13a - Basic Gate Charge Waveform











### Peak Diode Recovery dV/dt Test Circuit

• Compliment N-Channel of D.U.T. for driver

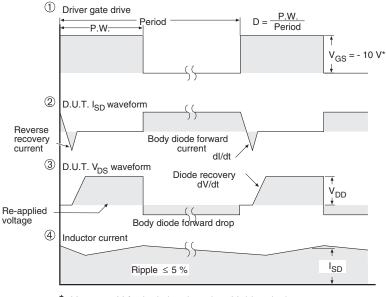




Fig. 14 - For P-Channel

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